

Title (en)

Process for stripping an area of a layer from a component

Title (de)

Verfahren zum Entfernen eines Schichtbereichs eines Bauteils

Title (fr)

Procédé d'élimination d'une zone pelliculaire d'un élément constituitif

Publication

EP 1752562 A1 20070214 (DE)

Application

EP 06020613 A 20030820

Priority

- EP 03809256 A 20030820
- EP 02023394 A 20021018
- EP 06020613 A 20030820

Abstract (en)

Removing a layer from a component comprises treating the component in a salt bath, subjecting it to thermal shock and then treating it with acid.

IPC 8 full level

C23G 1/32 (2006.01); **C23F 1/44** (2006.01); **F01D 5/00** (2006.01)

CPC (source: EP US)

C23F 1/44 (2013.01 - EP US); **C23G 1/32** (2013.01 - EP US); **F01D 5/005** (2013.01 - EP US)

Citation (search report)

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Designated contracting state (EPC)

DE ES FR GB IT

DOCDB simple family (publication)

EP 1411149 A1 20040421; CN 100392152 C 20080604; CN 1688749 A 20051026; DE 50305651 D1 20061221; EP 1552037 A1 20050713; EP 1552037 B1 20061108; EP 1752562 A1 20070214; EP 1752562 B1 20111005; ES 2275138 T3 20070601; ES 2372406 T3 20120119; JP 2006503186 A 20060126; US 2006231123 A1 20061019; US 2007131255 A1 20070614; WO 2004038068 A1 20040506

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